



HOSTAFORM® S 9364 XAP®2

Hostaform® acetal copolymer grade S 9364 XAP®2 is a highly impact modified grade for demanding applications. Hostaform® S 9364 XAP®2 provides a significant improvement in impact strength and flexibility over standard impact modified grades.

Hostaform® S 9364 XAP®2 exhibits exceptional low emission performance meeting or exceeding the requirements of many automotive markets. Chemical abbreviation according to ISO 1043-1: POM-HI

Product information

Resin Identification	POM-I		ISO 1043
Part Marking Code	>POM-I<		ISO 11469
Rheological properties			
Melt volume-flow rate	4	cm ³ /10min	ISO 1133
Temperature	190	°C	
Load	2.16	kg	
Moulding shrinkage, parallel	1.6		ISO 294-4, 2577
Moulding shrinkage, normal	1.5	%	ISO 294-4, 2577
Typical mechanical properties			
Tensile modulus	1650	MPa	ISO 527-1/-2
Tensile stress at yield, 50mm/min	43	MPa	ISO 527-1/-2
Tensile strain at yield, 50mm/min	16	%	ISO 527-1/-2
Flexural modulus	1550		ISO 178
Flexural stress at 3.5%		MPa	ISO 178
Charpy impact strength, 23°C		kJ/m ²	ISO 179/1eU
Charpy impact strength, -30 °C		kJ/m ²	ISO 179/1eU
Charpy notched impact strength, 23°C		kJ/m ²	ISO 179/1eA
Charpy notched impact strength, -30 °C		kJ/m² kJ/m²	ISO 179/1eA
Izod notched impact strength, 23°C Izod notched impact strength, -40°C		kJ/m ²	ISO 180/1A ISO 180/1A
Hardness, Rockwell, M-scale	48	NJ/III	ISO 2039-2
Poisson's ratio	0.42 ^[C]		130 2039-2
[C]: Calculated	0.42		
Thermal properties			
Melting temperature, 10°C/min	165		ISO 11357-1/-3
Temperature of deflection under load, 1.8 MPa		°C	ISO 75-1/-2
Temperature of deflection under load, 0.45 MPa	140		ISO 75-1/-2
Coefficient of linear thermal expansion	120	E-6/K	ISO 11359-1/-2
(CLTE), parallel	440	F 0/1/	100 11050 1/0
Coefficient of linear thermal expansion (CLTE), normal	110	E-6/K	ISO 11359-1/-2
Physical/Other properties			
Humidity absorption, 2mm	0.25	%	Sim. to ISO 62
Water absorption, 2mm	0.8	%	Sim. to ISO 62
Density	1360	kg/m ³	ISO 1183

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Injection

Drying Recommended	no	
Drying Temperature	100	°C
Drying Time, Dehumidified Dryer	3 - 4	h
Processing Moisture Content	≤0.2	%
Melt Temperature Optimum	190	°C
Min. melt temperature	180	°C
Max. melt temperature	200	°C
Screw tangential speed	≤0.3	m/s
Mold Temperature Optimum	65	°C
Min. mould temperature	60	°C
Max. mould temperature	70	°C
Hold pressure range	60 - 120	MPa
Back pressure	2	MPa

Characteristics

Processing Injection Moulding, Extrusion

Delivery form Pellets

Additives Release agent

Special characteristics High impact or impact modified, Low emissions

Additional information

Processing Notes Pre-Drying

Drying is suggested to help achieve low emission performance and to counter if material has contacted moisture through improper storage and handling.

Automotive

OEM STANDARD ADDITIONAL INFORMATION

BAIC Q-BJEV 01.59
Ford WSK-M4D618-A2

 Li Auto
 Q/LiA5310020
 2021 (V2)

 Mercedes-Benz
 DBL5404
 BQF

Mercedes-Benz DBL5410

Renault No Spec, Special Part Approval, See Your CE

Account Manager.

SAIC Motor SMTC 5 310 020

 VW Group
 TL 522 77

 VW Group
 VW 50180

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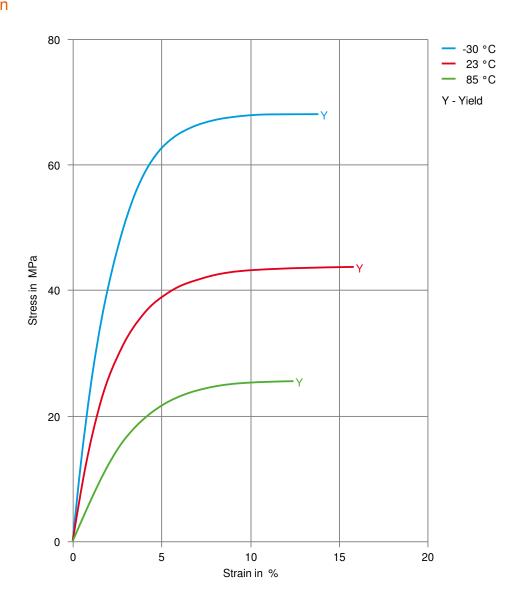
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Stress-strain



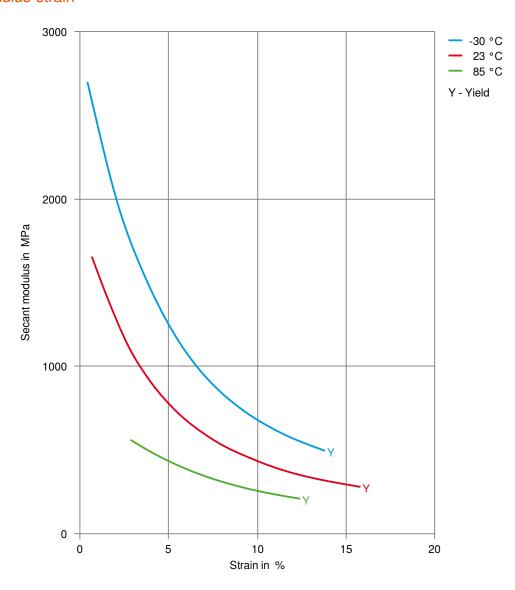
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Secant modulus-strain



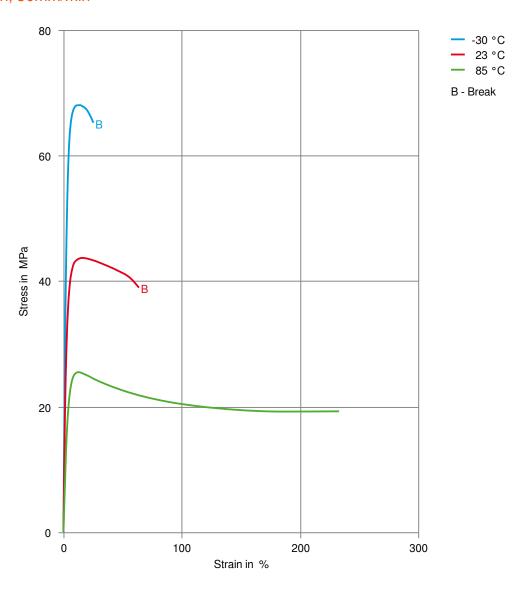
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Stress-strain, 50mm/min



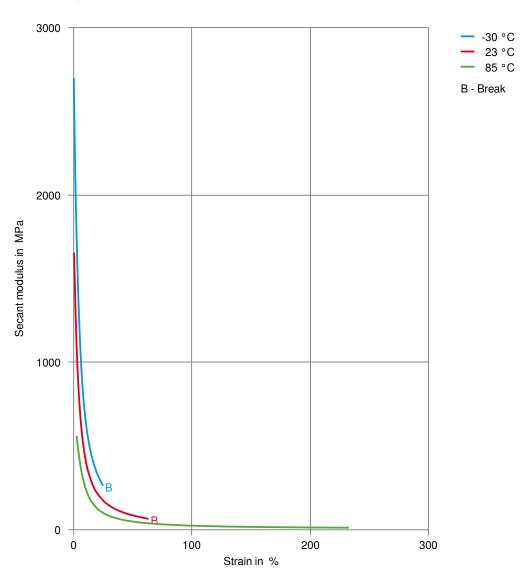
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Secant modulus-strain, 50mm/min



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